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Lin

(54) PHOTO-ELECTRIC CONVERTING MODULE HAVING OPPOSITE CAVITIES

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- (58) Field of Classification Search CPC H04B 1/587

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250/208.1

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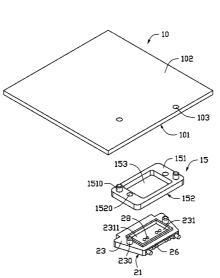
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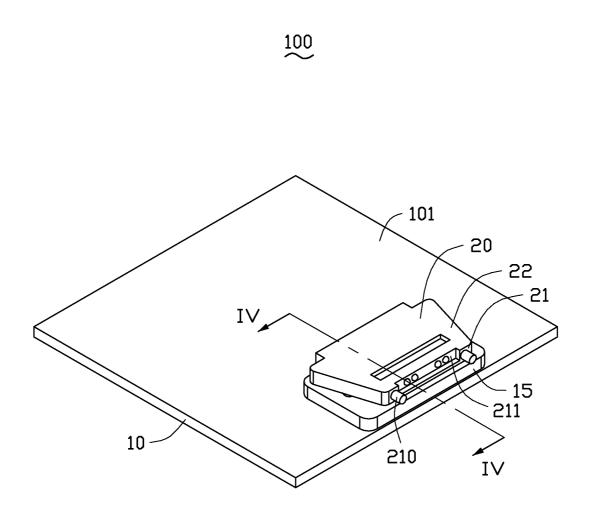
(57) **ABSTRACT**

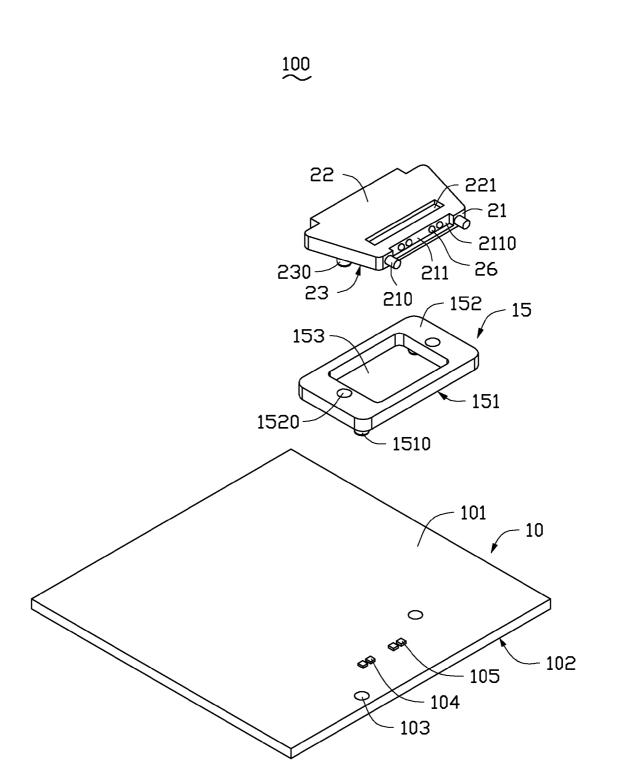
An optical-electric converting module includes a printed circuit board (PCB), a bracket and an optical-electric coupling element. The PCB includes a supporting surface, at least one laser diode and at least one photo diode. The at least one laser diode and the at least one photo diode are positioned on the supporting surface and electrically connected to the PCB. The bracket includes a first surface and a second surface facing away from the first surface. The first surface rests on the supporting surface. The bracket defines a through window running through the first surface and the second surface. The bracket is detachably connected to the supporting surface of the PCB, with the at least one laser diode and the at least one photo diode being received in the through window. The optical-electric coupling element is detachably connected to the second surface of the bracket.

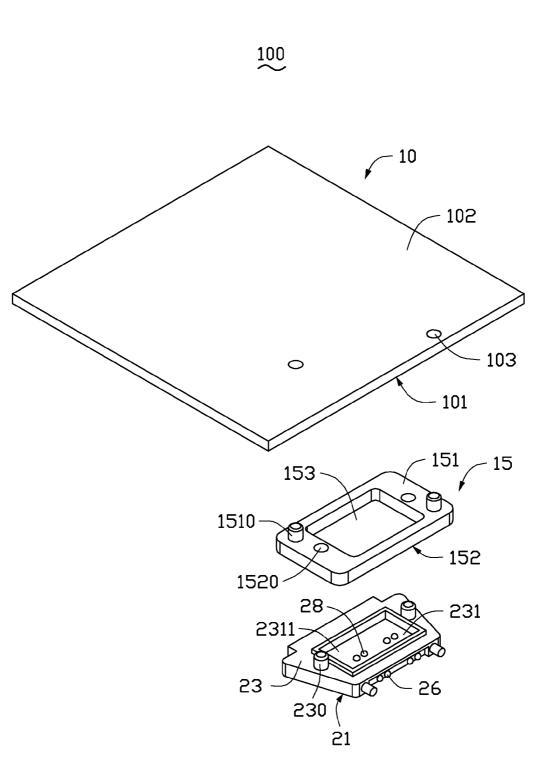
16 Claims, 4 Drawing Sheets

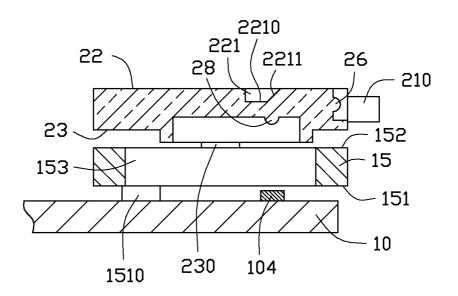
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PHOTO-ELECTRIC CONVERTING MODULE HAVING OPPOSITE CAVITIES

BACKGROUND

1. Technical Field

The present disclosure relates to optical-electric converting modules, and particularly to an optical-electric converting module which has a bracket.

2. Description of Related Art

An optical-electric converting module usually includes a circuit board, a number of light emitters, a number of light receivers, and a optical-electric coupling member. The light emitters and the light receivers are mounted on and electrically connected to the circuit board. The optical-electric cou-1 pling member includes a number of coupling lenses and is adhered to the circuit board by adhesive. Each of the light emitters and the light receivers is precisely aligned with a coupling lens. In use, light beams emitted by each light emitter project into the optical-electric coupling member through 20 a coupling lens and are then emitted out from the opticalelectric coupling member. External light beams are projected into the optical-electric coupling member, pass through a coupling lens, and are then projected into a light receiver. The optical-electric coupling member is adhered to the circuit ²⁵ board by the adhesive and the adhesive may not be strong enough to withstand shocks and jars, the optical-electric coupling member will readily shift when an external force is applied and misalignment between the coupling lenses and the light emitters and the light receivers is the result.

Therefore, it is desirable to provide an optical-electric converting module which can overcome the above-mentioned limitations.

BRIEF DESCRIPTION OF THE DRAWINGS

Many aspects of the present disclosure can be better understood with reference to the following drawings. The components in the drawings are not necessarily drawn to scale, the emphasis instead being placed upon clearly illustrating the ⁴⁰ principles of the present disclosure.

FIG. 1 is an isometric view of an optical-electric converting module, according to an exemplary embodiment.

FIG. **2** is an exploded, isometric view of the optical-electric converting module of FIG. **1**.

FIG. **3** is similar to FIG. **2**, but viewed from another angle. FIG. **4** is a cross-sectional view taken along line IV-IV of FIG. **1**.

DETAILED DESCRIPTION

FIGS. 1-4 show an optical-electric converting module 100, according to an embodiment. The optical-electric converting module 100includes a printed circuit board (PCB) 10,a bracket 15 and an optical-electric coupling element 20. The 55 bracket 15 is detachably connected to the PCB 10. The optical-electric coupling element 20 is detachably connected to the bracket 15.

The PCB 10 includes a supporting surface 101 and a rear surface 102 facing away from the supporting surface 101. The 60 PCB 10 defines two first locating holes 103 running through the supporting surface 101 and the rear surface 102. Four photoelectric conversion chips, such as two laser diodes 104 and two photo diodes 105, are positioned on the supporting surface 101. The PCB 10 contains various circuits (not 65 shown) that connect with the two laser diodes 104 and the two photo diodes 105, to drive the laser diodes 104 comit light,

and for the demodulation of data in the light received by the photo diodes **105**. In the embodiment, the two laser diodes **104** and the two photo diodes **105**are positioned between the two first locating holes **103**.

The bracket 15 includes a first surface 151 and a second surface 152 facing away from the first surface 151. The bracket 15 defines a through window 153 running through the first surface 151 and the second surface 152. The first surface 151 rests on the supporting surface 101. The bracket 15 includes two first locating poles 1510 perpendicularly extending downwards from the first surface 151. The shape and size of the first locating poles 1510 correspond to the shape and size of the first locating holes 103. When assembling, the first locating poles 1510 are inserted into the first locating holes 103 as a pinch fit to firmly attach the bracket 15 onto the supporting surface 101 of the PCB 10, with the two laser diodes 104 and the two photo diodes 105 being received in the through window 153. When disassembling, the first locating poles 1510 are detached from the first locating holes 103 via pulling the bracket 15 along a direction away from the PCB 10 or pulling the PCB 10 along a direction away from the bracket 15.

In the embodiment, the first locating poles **1510** are integrally formed with the bracket **15**. Alternatively, the first locating poles **1510** and the bracket **15** may be separately formed. The first locating poles **1510** can be attached to the bracket **15** by adhesive, plastic welding or other attaching method. All of the first locating poles **1510** have essentially identical height to promote even loading thereon.

The bracket **15** also defines two second locating holes **1520** running through the first surface **151** and the second surface **152**.

The optical-electric coupling element 20 includes a first side surface 21, an upper surface 22 and a lower surface 23 facing away from the upper surface 22. The upper surface 22 is substantially parallel with the lower surface 21. The first side surface 21 perpendicularly connects the upper surface 22 and the lower surface 23. The optical-electric coupling element 20 defines a first cavity 231 in the lower surface 23. A bottom portion 2311 of the first cavity 231 forms four first coupling lenses 28. In the embodiment, all of the first coupling lenses 28 are convex lenses and are integrally formed with the optical-electric coupling element 20.

The optical-electric coupling element 20 includes two second locating poles 230 perpendicularly extending downwards from the lower surface 23. In the embodiment, the second locating poles 230 are symmetrical about the first 50 cavity 231. The shape and size of the second locating poles 230 correspond to the shape and size of the second locating holes 1520. As such, when assembling, the second locating poles 230 are inserted into the second locating holes 1520 as a pinch fit to firmly attach the optical-electric coupling element 20 onto the bracket 15, with each of the first coupling lens 28 aligning with a laser diode 104 or a photo diode 105. When disassembling, the second locating poles 230 are detached from the second locating holes 1520 via pulling the optical-electric coupling element 20 along a direction away from the bracket 15 or pulling the bracket 15 along a direction away from the optical-electric coupling element 20.

In the embodiment, the second locating poles 230 are integrally formed with the optical-electric coupling element 20. Alternatively, the second locating poles 230 and the opticalelectric coupling element 20 may be separately formed. The second locating poles 230 can be attached to the opticalelectric coupling element 20 by adhesive, plastic welding or

other attaching method. All of the second locating poles **230** have essentially identical height to promote even loading thereon.

The optical-electric coupling element **20** also defines a second cavity **221** in the upper surface **22**. The second cavity **5 221** includes a bottom surface **2210** and a sloped surface **2211** directly connected to the bottom surface **2210**. The bottom surface **2210** is substantially parallel with the upper surface **22.** An included angle between the bottom surface **2210** and the sloped surface **2211** is about 45 degrees. An angle 10 between an optical axis of each first coupling lens **28** and the sloped surface **2211** is therefore about 45 degrees.

The optical-electric coupling element **20** also defines a receiving cavity **211** in the first side surface **21**. The receiving cavity **211** includes a vertical surface **2110** substantially per- 15 pendicular to the upper surface **22**. The vertical surface **2110** forms four second coupling lenses **26**. In the embodiment, all of the second coupling lenses **26** are convex lenses and are integrally formed with the optical-electric coupling element **20**. Each of the second coupling lenses **26** corresponds to one 20 of the first coupling lenses **28**. Two positioning poles **210** perpendicularly extend upwards from the first side surface **21**. In the embodiment, the two positioning poles **210** are symmetrical about the receiving cavity **211**.

In use, light emitted from the two laser diodes **104** is 25 directed into the optical-electric coupling element **20** by two of the first coupling lenses **28**, and the light path is bent about 90 degrees by the sloped surface **2211**. In the embodiment, the second coupling lenses **26** are positioned on the light path from the sloped surface **2211**. As such, the light is finally 30 reflected into the two optical fibers (not shown) by the second coupling lenses **26**. A process of the photo diodes **105** receiving light is the reverse of that of the laser diodes **104** emitting light.

In other embodiments, the numbers of the laser diodes **104**, 35 the photo diodes **105**, the first coupling lenses **28** and the second coupling lenses **26** can be changed depending on need.

It will be understood that the above particular embodiments are shown and described by way of illustration only. 40 The principles and the features of the present disclosure may be employed in various and numerous embodiment thereof without departing from the scope of the disclosure as claimed. The above-described embodiments illustrate the possible scope of the disclosure but do not restrict the scope of the 45 disclosure.

What is claimed is:

1. An optical-electric converting module, comprising:

- a printed circuit board (PCB) comprising a supporting surface, at least one laser diode and at least one photo 50 diode, the at least one laser diode and the at least one photo diode positioned on the supporting surface and electrically connected to the PCB;
- a bracket comprising a first surface and a second surface facing away from the first surface, the first surface resting on the supporting surface, the bracket defining a through window running through the first surface and the second surface, the bracket detachably connected to the supporting surface of the PCB, with the at least one laser diode and the at least one photo diode being 60 received in the through window; and
- an optical-electric coupling element detachably connected to the second surface of the bracket, and comprising a lower surface and an upper surface facing away from the lower surface, the upper surface being substantially par-65 allel with the lower surface, the optical-electric coupling element defining a first cavity in the lower surface, and a

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second cavity in the upper surface, the second cavity comprising a bottom surface and a sloped surface directly connected to the bottom surface, the bottom surface being substantially parallel with the upper surface, and an included angle between the bottom surface and the sloped surface being about 45 degrees; wherein the PCB comprises a rear surface facing away from the supporting surface, the PCB defines two first locating holes running through the supporting surface and the rear surface, the bracket comprises two first locating poles perpendicularly extending downwards from the first surface, and the first locating poles are inserted into the first locating hole as a pinch fit to firmly attach the bracket onto the PCB; the bracket defines two second locating holes running through the first surface and the second surface, the optical-electric coupling element comprises a lower surface, the optical-electric coupling element comprises two second locating poles perpendicularly extending downwards from the lower surface, and the second locating poles are inserted into the second locating holes as a pinch fit to firmly attach the optical-electric coupling element onto the second surface of the bracket.

2. The optical-electric converting module of claim 1, wherein the at least one laser diode and the at least one photo diode are positioned between the two first locating holes.

3. The optical-electric converting module of claim **1**, wherein the first locating poles are capable of being detached from the first locating holes via pulling the bracket along a direction away from the PCB or pulling the PCB along a direction away from the bracket.

4. The optical-electric converting module of claim 1, wherein the first locating poles are integrally formed with the bracket.

5. The optical-electric converting module of claim 1, wherein the first locating poles are attached to the bracket.

6. The optical-electric converting module of claim 1, wherein the second locating poles are capable of being detached from the second locating holes via pulling the optical-electric coupling element along a direction away from the bracket or pulling the bracket along a direction away from the optical-electric coupling element.

7. The optical-electric converting module of claim 1, wherein the second locating poles are integrally formed with the optical-electric coupling element.

8. The optical-electric converting module of claim **1**, wherein the second locating poles are attached to the optical-electric coupling element.

9. The optical-electric converting module of claim 1, wherein a bottom portion of the first cavity forms at least two first coupling lenses, and each of the at least two first coupling lenses aligning with a respective one of the at least one laser diode and the at least one photo diode.

bracket comprising a first surface and a second surface facing away from the first surface, the first surface resting on the supporting surface, the bracket defining a through window running through the first surface and

11. The optical-electric converting module of claim 9, wherein an angle between an optical axis of each first coupling lens and the sloped surface is about 45 degrees.

12. The optical-electric converting module of claim 9, wherein the optical-electric coupling element comprises a side surface, the side surface perpendicularly connects the upper surface and the lower surface, the optical-electric coupling element defines a receiving cavity in the side surface, the receiving cavity comprises a vertical surface substantially perpendicular to the upper surface, the vertical surface forms

at least two second coupling lenses, and each of the at least two second coupling lenses corresponds to a respective one of the at least two first coupling lenses.

13. The optical-electric converting module of claim **12**, wherein the at least two second coupling lenses are positioned 5 on a light path of the sloped surface.

14. The optical-electric converting module of claim 12, wherein all of the at least two second coupling lenses are convex lenses and are integrally formed with the optical-electric coupling element.

15. The optical-electric converting module of claim **12**, wherein the optical-electric coupling element comprises two positioning poles perpendicularly extending from the side surface.

16. The optical-electric converting module of claim **15**, 15 wherein the two positioning poles are symmetrical about the receiving cavity.

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